RENESAS Low Skew, ÷1, ÷2 LVCMOS/LVTTL Clock Generator

DATASHEET

GENERAL DESCRIPTION

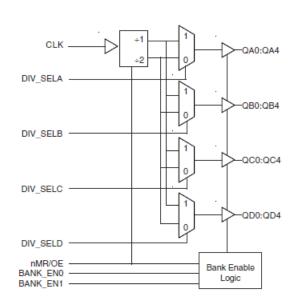
The 8701 is a low skew, $\div 1$, $\div 2$ LVCMOS/LVTTL Clock Generator . The low impedance LVCMOS outputs are designed to drive 50Ω series orparallel terminated transmission lines. The effective fanout can be increased from 20 to 40 by utilizing the ability of the outputs to drive two series terminated lines.

The divide select inputs, DIV_SELx, control the output frequency of each bank. The outputs can be utilized in the \div 1, \div 2 or a combination of \div 1 and \div 2 modes. The bank enable inputs, BANK_EN0:1, support enabling and disabling each bank of outputs individually. The master reset input, nMR/OE, resets the internal frequency dividers and also controls the active and high impedance states of all outputs.

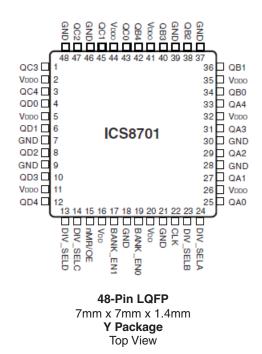
The 8701 is characterized at 3.3V and mixed 3.3V input supply, and 2.5V output supply operating modes. Guaranteed bank, output and part-to-part skew characteristics make the 8701 ideal for those clock distribution applications demanding well defined performance and repeatability.

FEATURES

- Twenty LVCMOS outputs, 7Ω typical output impedance
- One LVCMOS/LVTTL clock input
- Maximum output frequency: 250MHz
- Bank enable logic allows unused banks to be disabled in reduced fanout applications
- Output skew: 250ps (maximum)
- Part-to-part skew: 600ps (maximum)
- Bank skew: 200ps (maximum)
- Multiple frequency skew: 300ps (maximum)
- 3.3V or mixed 3.3V input, 2.5V output operating supply modes
- 0°C to 70°C ambient operating temperature
- · Other divide values available on request
- · Available in lead-free RoHS compliant package



PIN ASSIGNMENT



BLOCK DIAGRAM

TABLE 1. PIN DESCRIPTIONS

Number	Name	Т	уре	Description
2, 5, 11, 26, 32, 35, 41, 44	V _{ddo}	Power		Output supply pins.
7, 9, 18, 21, 28, 30, 37, 39, 46, 48	GND	Power		Power supply ground.
16, 20	V _{DD}	Power		Positive supply pins.
25, 27, 29, 31, 33	QA0, QA1, QA2, QA3, QA4	Output		Bank A outputs.LVCMOS / LVTTLinterface levels. 7Ω typical output impedance.
34, 36, 38, 40, 42	QB0, QB1, QB2, QB3, QB4	Output		Bank B outputs.LVCMOS / LVTTLinterface levels. 7Ω typical output impedance.
43, 45, 47, 1, 3	QC0, QC1, QC2, QC3, QC4	Output		Bank C outputs.LVCMOS / LVTTLinterface levels. 7Ω typical output impedance.
4, 6, 8, 10, 12	QD0, QD1, QD2, QD3, QD4	Output		Bank D outputs. LVCMOS / LVTTLinterface levels. 7Ω typical output impedance.
22	CLK	Input	Pulldown	LVCMOS / LVTTL clock input.
13	DIV_SELD	Input	Pullup	Controls frequency division for Bank D outputs. LVCMOS / LVTTLinterface levels.
14	DIV_SELC	Input	Pullup	Controls frequency division for Bank C outputs. LVCMOS / LVTTLinterface levels.
23	DIV_SELB	Input	Pullup	Controls frequency division for Bank B outputs. LVCMOS / LVTTLinterface levels.
24	DIV_SELA	Input	Pullup	Controls frequency division for Bank A outputs. LVCMOS / LVTTLinterface levels.
17, 19	BANK_EN1, BANK_EN0	Input	Pullup	Enables and disables outputs by banks. LVCMOS / LVTTLinterface levels.
15	nMR/OE	Input	Pullup	Master Reset and output enable. When HIGH, output drivers are enabled. Whe LOW, output drivers are in HiZ and dividers are reset. LVCMOS / LVTTLinterface levels.

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLUP}	Input Pullup Resistor			51		kΩ
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ
C _{PD}	Power Dissipation Capacitance (per output)	$V_{_{DD}}, V_{_{DDO}} = 3.465 V$			15	pF
R _{OUT}	Output Impedance			7		Ω

TABLE 3. FUNCTION TABLE

Inputs				Outputs				
nMR/OE	BANK_EN1	BANK_EN0	DIV_SELx	QA0:QA4	QB0:QB4	QC0:QC4	QD0:QD4	Qx Frequency
0	Х	Х	Х	Hi Z	Hi Z	Hi Z	Hi Z	zero
1	0	0	0	Active	Hi Z	Hi Z	Hi Z	fIN/2
1	1	0	0	Active	Active	Hi Z	Hi Z	fIN/2
1	0	1	0	Active	Active	Active	Hi Z	fIN/2
1	1	1	0	Active	Active	Active	Active	fIN/2
1	0	0	1	Active	Hi Z	Hi Z	Hi Z	fIN
1	1	0	1	Active	Active	Hi Z	Hi Z	fIN
1	0	1	1	Active	Active	Active	Hi Z	fIN
1	1	1	1	Active	Active	Active	Active	fIN

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V _{DD}	4.6V
Inputs, V _I	-0.5V to $V_{_{\rm DD}}$ + 0.5 V
Outputs, V _o	-0.5V to V_{DDO} + 0.5V
Package Thermal Impedance, $\boldsymbol{\theta}_{_{JA}}$	47.9°C/W (0 lfpm)
Storage Temperature, $T_{_{STG}}$	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 4A. Power Supply DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$, Ta = 0°C to 70°C to 70

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{DD}	Positive Supply Voltage		3.135	3.3	3.465	V
V _{DDO} O	Output Supply Voltage		3.135	3.3	3.465	V
			2.375	2.5	2.625	V
I _{DD}	Power Supply Current				95	mA

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V _{IH}	Input High Voltage	DIV_SELA, DIV_SELB, DIV_SELC, DIV_SELD, BANK_EN0, BANK_EN1, nMR/OE		2		V _{DD} + 0.3	V
		CLK		2		V _{DD} + 0.3	V
V _{IL}	Input Low Voltage	DIV_SELA, DIV_SELB, DIV_SELC, DIV_SELD, BANK_EN0, BANK_EN1, nMR/OE		-0.3		0.8	V
		CLK		-0.3		1.3	V
I _{IH}	Input High Current	DIV_SELA, DIV_SELB, DIV_SELC, DIV_SELD, BANK_EN0, BANK_EN1, nMR/OE	$V_{DD} = _{VIN} = 3.465V$			5	μΑ
		CLK	$V_{DD} = _{VIN} = 3.465V$			150	μA
I _{IL}	Input Low Current	DIV_SELA, DIV_SELB, DIV_SELC, DIV_SELD, BANK_EN0, BANK_EN1, nMR/OE	$V_{_{DD}} = 3.465 V, _{_{VIN}} = 0 V$	-150			μΑ
		CLK	$V_{_{DD}} = 3.465 V, _{_{VIN}} = 0 V$	-5			μA
			$V_{_{DD}} = V_{_{DDO}} = 3.135V$ $I_{_{OH}} = -36mA$	2.6			V
V _{oh}	Output High Voltage		$V_{_{DD}} = 3.135V,$ $V_{_{DDO}} = 2.375$ $I_{_{OH}} = -27mA$	1.8			V
			$V_{_{DD}} = V_{_{DDO}} = 3.135V$ $I_{_{OL}} = 36mA$			0.5	V
V _{ol}	Out	put Low Voltage	$V_{_{DD}} = 3.135V,$ $V_{_{DDO}} = 2.375$ $I_{_{OL}} = 27mA$			0.5	V

$\textbf{Table 4B. LVCMOS DC Characteristics, V}_{\text{dd}} = 3.3V \pm 5\%, V_{\text{ddo}} = 3.3V \pm 5\% \text{ or } 2.5V \pm 5\%, Ta = 0^{\circ}\text{C to } 70^{\circ}\text{C}$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency				250	MHz
t _{PD}	Propagation Delay; NOTE 1	$f \le 200 MHz$	2.2		3.4	ns
tsk(b)	Bank Skew; NOTE 2, 7	Measured on rising edge $atV_{DDO}/2$			200	ps
tsk(o)	Output Skew; NOTE 3, 7	Measured on rising edge $atV_{DDO}/2$			250	ps
tsk(w)	Multiple Frequency Skew; NOTE 4, 7	Measured on rising edge $atV_{DDO}/2$			300	ps
tsk(pp)	Part-to-Part Skew; NOTE 5, 7	Measured on rising edge $atV_{DDO}/2$			600	ps
t _R	Output Rise Time; NOTE 6	30% to 70%	280		850	ps
t _F	Output Fall Time; NOTE 6	30% to 70%	280		850	ps
odc	Output Duty Cycle	f ≤ 200MHz	tCYCLE/2 - 0.5	tCYCLE/2	tCYCLE/2 + 0.5	ns
		f = 200MHz	2	2.5	3	ns
t _{en}	Output Enable Time; NOTE 6	f = 10MHz			6	ns
t _{DIS}	Output Disable Time; NOTE 6	f = 10MHz			6	ns

Table 5A. AC Characteristics, $V_{DD} = V_{DDO} = 3.3V \pm 5\%$, TA =0°C to 70°C

All parameters measured at 200MHz unless noted otherwise.

NOTE 1: Measured from the $V_{_{\rm DD}}\!/2$ of the input to $V_{_{\rm DDO}}\!/2$ of the output.

NOTE 2: Defined as skew within a bank of outputs at the same supply voltages and with equal load conditions.

NOTE 3: Defined as skew between outputs at the same supply voltage and with equal load conditions.

Measured at $V_{_{DDO}}/2$. NOTE 4: Defined as skew across banks of outputs operating at different frequency with the same supply voltages and equal load conditions.

NOTE 5: Defined as skew between outputs on different devices operating at the same supply voltages and

with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{\text{DDO}}/2$.

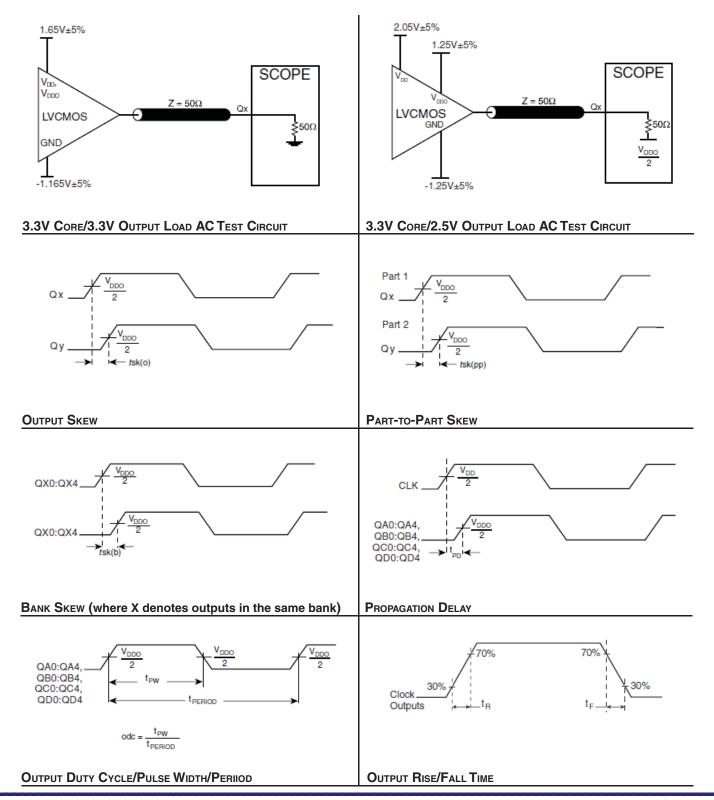
NOTE 6: These parameters are guaranteed by characterization. Not tested in production.

NOTE 7: This parameter is defined in accordance with JEDEC Standard 65.

TABLE 5B. AC CHARACTERISTICS	, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 2.5V \pm 5\%$, TA = 0°C to 70°C
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Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency				250	MHz
t _{PD}	Propagation Delay; NOTE 1	$f \le 200 MHz$	2.6		3.6	ns
tsk(b)	Bank Skew; NOTE 2, 7	Measured on rising edge $atV_{DDO}/2$			225	ps
tsk(o)	Output Skew; NOTE 3, 7	Measured on rising edge atV _{DDO} /2			250	ps
tsk(w)	Multiple Frequency Skew; NOTE 4, 7	Measured on rising edge atV _{DDO} /2			300	ps
tsk(pp)	Part-to-Part Skew; NOTE 5, 7	Measured on rising edge $atV_{DDO}/2$			600	ps
t _R	Output Rise Time; NOTE 6	30% to 70%	280		850	ps
t _F	Output Fall Time; NOTE 6	30% to 70%	280		850	ps
odc	Output Duty Cycle	f ≤ 200MHz	tCYCLE/2 - 0.5	tCYCLE/2	tCYCLE/2 + 0.5	ns
		f = 200MHz	2	2.5	3	ns
t _{en}	Output Enable Time; NOTE 6	f = 10MHz			6	ns
t _{DIS}	Output Disable Time; NOTE 6	f = 10MHz			6	ns

For notes, please see T5A above.



PARAMETER MEASUREMENT INFORMATION



APPLICATION INFORMATION

Driver Termination

For LVCMOS Output Termination, please refer to a separate Application Note: *LVCMOS Driver Termination.*

RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

INPUTS: LVCMOS CONTROL PINS: All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional

protection. A $1k\Omega$ resistor can be used.

OUTPUTS: LVCMOS OUTPUT: All unused LVCMOS output can be left floating. We recommend that there is no trace attached.

Power Considerations

For Power Dissipation, please refer to a separate Application Note: *Power Dissipation for LVCMOS Buffer.*

RELIABILITY INFORMATION

Table 6. $\boldsymbol{\theta}_{JA} \text{vs.}$ Air Flow Table for 48 Lead LQFP

	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

TRANSISTOR COUNT

The transistor count for 8701 is: 1743

D θ D2 Ref. H 1-INDEX AREA E2 EÌ Ref. E ¥ N-EI \Box θ DI SEATING PLANE - C -Ł ⊃ ccc C - A1 -c -b

PACKAGE OUTLINE - Y SUFFIX FOR 48 LEAD LQFP

TABLE 7. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS						
SYMBOL	BBC					
STMBOL	MINIMUM	NOMINAL	MAXIMUM			
Ν		48				
А			1.60			
A1	0.05		0.15			
A2	1.35	1.40	1.45			
b	0.17	0.22	0.27			
с	0.09		0.20			
D	9.00 BASIC					
D1		7.00 BASIC				
D2		5.50 Ref.				
E		9.00 BASIC				
E1		7.00 BASIC				
E2		5.50 Ref.				
е		0.50 BASIC				
L	0.45	0.60	0.75			
θ	0°		7°			
ccc			0.08			

Reference Document: JEDEC Publication 95, MS-026

TABLE 8. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
8701CYLF	ICS8701CYLF	48 Lead "Lead-Free" LQFP	tray	0°C to 70°C
8701CYLFT	ICS8701CYLF	48 Lead "Lead-Free" LQFP	1000 tape & reel	0°C to 70°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

Rev	Table	Page	Description of Change	Date
в	5A 5B	5 7 8 - 10	Updated notes. Updated notes. Updated drawings	10/4/01
с	4B 4D	4 6 11	Revised V _{IH} rows from 3.8 Maximum to V _{DD} + 0.3 Maximum. Revised V _{IH} rows from 3.8 Maximum to V _{DD} + 0.3 Maximum. Added Power Dissipation and Driver Termination notes.	11/28/01
С	1	2 9	Pin Description Table, revised nMR/OE description. Updated Output Rise/Fall Time Diagram.	8/19/02
D	T2 T8	1 3 7 8 11	Features Section - added lead-free bullet. Pin Characteristics Table - Changed CIN from 4pF max to 4pF typical. Parameter Measurement Information - added Bank Skew diagram. Application Information - added Recommenations for Unused Input and Output Pins. Ordering Information Table - added lead-free part number, marking and note. Updated format throughout the data sheet.	2/27/06
E	Т8	11 13	Updated datasheet's header/footer with IDT from ICS. Removed ICS prefix from Part/Order Number column. Added Contact Page.	7/31/10
F	Т8	11	Ordering Information - removed leaded devices. PDN CQ-13-02. Updated format throughout the data sheet.	1/22/15



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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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